
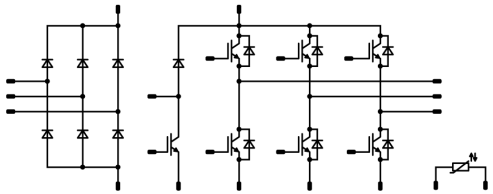




flowPIM E1	650 V / 30 A
Topology features <ul style="list-style-type: none">• Open Emitter configuration• Temperature sensor• Converter+Brake+Inverter	flow E1 12 mm housing 
Component features <ul style="list-style-type: none">• Easy paralleling• Low collector emitter saturation voltage• Low turn-off losses• Positive temperature coefficient	
Housing features <ul style="list-style-type: none">• Base isolation: Al₂O₃• Convex shaped substrate for superior thermal contact• Compact housing• CTI600 housing material• Thermo-mechanical push-and-pull force relief• Solder pin	
Target applications <ul style="list-style-type: none">• Industrial Drives	
Types <ul style="list-style-type: none">• 10-E107PMA030I7-L926A28Z	
	Schematic 



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10-E107PMA030I7-L926A28Z
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	40	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	90	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	66	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 400\text{ V}$ $T_j = 150\text{ °C}$	3	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Inverter Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	38	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	90	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	61	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Brake Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	40	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	90	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	66	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 400\text{ V}$ $T_j = 150\text{ °C}$	3	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Brake Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	28	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	50	W
Maximum junction temperature	T_{jmax}		175	°C

Rectifier Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	47	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	270	A
Surge current capability	I^2t		370	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	61	W
Maximum junction temperature	T_{jmax}		150	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Creepage distance			>12,7	mm
Clearance			>12,7	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0003	25	4,35	5	5,65	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		30	25 125 150		1,3 1,37 1,39	1,65 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			20	μA
Gate-emitter leakage current	I_{GES}		0	650		25			100	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							1900		pF
Output capacitance	C_{oes}	$f = 1 \text{ Mhz}$	0	25		25		62		pF
Reverse transfer capacitance	C_{res}							20		pF
Gate charge	Q_g	$V_{CC} = 520 \text{ V}$	15		30	25		180		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,45		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		121,73 125,39 126,41		ns
Rise time	t_r					25 125 150		44,03 43,86 43,11		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		150,47 176,6 182,17		ns
Fall time	t_f					25 125 150		34,48 64,88 71,91		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 0,549 \mu\text{C}$ $Q_{tFWD} = 1,33 \mu\text{C}$ $Q_{tFWD} = 1,57 \mu\text{C}$				25 125 150		1,17 1,52 1,62		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,633 0,973 1,08		mWs



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datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit	
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max			
Inverter Diode											
Static											
Forward voltage	V_F				30	25 125 150		1,63 1,53 1,5	2 ⁽¹⁾	V	
Reverse leakage current	I_R	$V_r = 650$ V				25			20	μA	
Thermal											
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,56		K/W	
Dynamic											
Peak recovery current	I_{RM}	$di/dt=625$ A/μs $di/dt=522$ A/μs $di/dt=599$ A/μs	±15	350	40	25		8,51		A	
						125		14,04			
						150		15,31			
Reverse recovery time	t_{rr}					25		94,96			ns
						125		142,55			
						150		157,9			
Recovered charge	Q_r					25		0,549		μC	
						125		1,33			
						150		1,57			
Reverse recovered energy	E_{rec}					25		0,086		mWs	
						125		0,237			
						150		0,283			
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					25		785,89		A/μs	
						125		296,08			
						150		209,55			



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datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	

Brake Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0003	25	4,35	5	5,65	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		30	25 125 150		1,3 1,37 1,39	1,65 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			20	μA
Gate-emitter leakage current	I_{GES}		0	650		25			100	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							1900		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		62		pF
Reverse transfer capacitance	C_{res}							20		pF
Gate charge	Q_g	$V_{CC} = 520$ V	15		30	25		180		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,45		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		29,53 32,7 33,3		ns
Rise time	t_r					25 125 150		40,52 42,98 43,05		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		322,21 350,45 357,62		ns
Fall time	t_f					25 125 150		22,66 29,66 30,75		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 0,447$ μC $Q_{tFWD} = 1,04$ μC $Q_{tFWD} = 1,22$ μC				25 125 150		1,31 1,7 1,77		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,844 1,16 1,28		mWs



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datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Brake Diode										
Static										
Forward voltage	V_F				20	25 125 150		1,71 1,6 1,55	2 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 650$ V				25			20	μA
Thermal										
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,9		K/W
Dynamic										
Peak recovery current	I_{RM}	$di/dt=523$ A/μs $di/dt=609$ A/μs $di/dt=557$ A/μs	0/15	400	40	25 125 150		6,84 10,85 11,7		A
Reverse recovery time	t_{rr}					25 125 150		94,94 140,32 157,52		ns
Recovered charge	Q_r					25 125 150		0,447 1,04 1,22		μC
Reverse recovered energy	E_{rec}					25 125 150		0,081 0,209 0,252		mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					25 125 150		241,94 195,24 161,14		A/μs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Rectifier Diode

Static

Forward voltage	V_F				28	25 125		1,15 1,1	1,5 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1600$ V				25 150			100 1000	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,15		K/W
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Thermistor

Static

Rated resistance	R					25		5		kΩ
Deviation of R100	$\Delta_{R/R}$	$R_{100} = 499$ Ω				100	3,2		3,3	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,3		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3380		K
Vincotech Thermistor Reference									V	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.

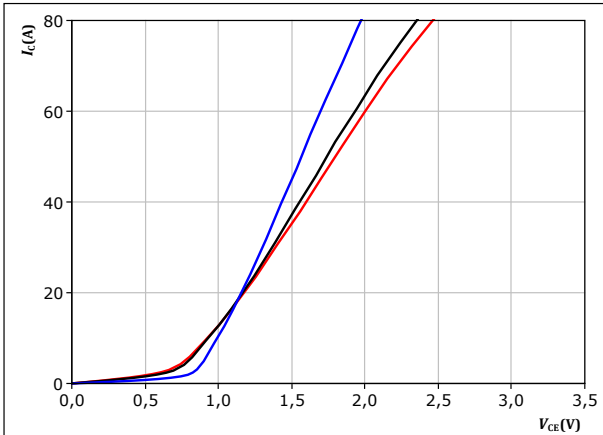


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

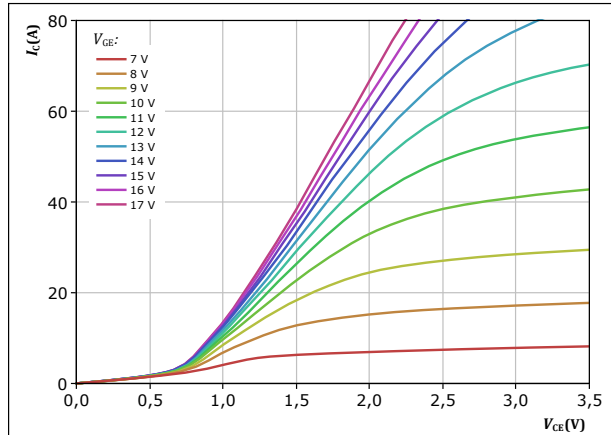


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j:$ 25 °C, 125 °C, 150 °C

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

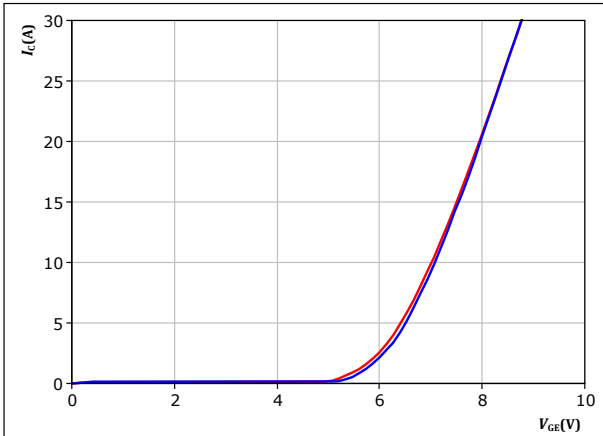


$t_p = 250 \mu s$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

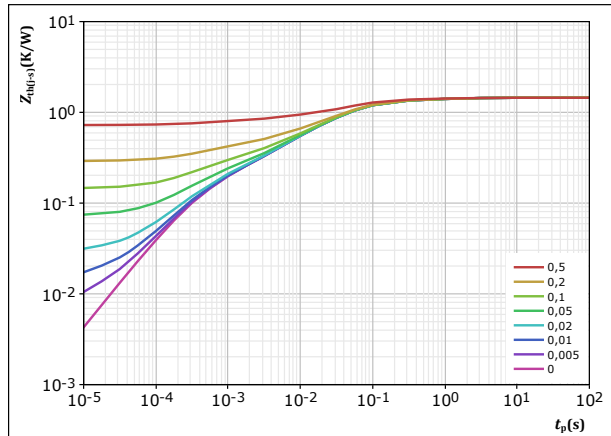


$t_p = 250 \mu s$
 $V_{CE} = 9 V$
 $T_j:$ 125 °C, 150 °C

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,448 \text{ K/W}$
 IGBT thermal model values

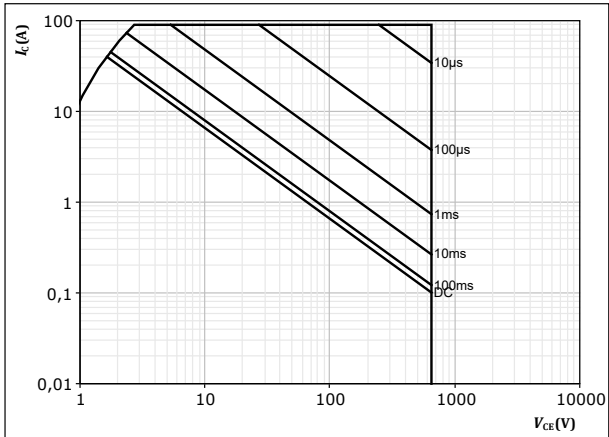
R (K/W)	τ (s)
8,39E-02	1,48E+00
2,97E-01	1,38E-01
7,21E-01	3,10E-02
2,11E-01	3,93E-03
1,36E-01	3,86E-04



Inverter Switch Characteristics

figure 5. IGBT

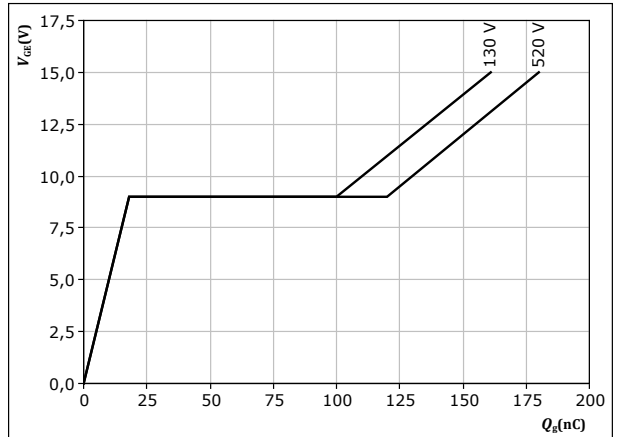
Safe operating area
 $I_C = f(V_{CE})$



$D =$ single pulse
 $T_s = 80$ °C
 $V_{GE} = 15$ V
 $T_j = T_{jmax}$

figure 6. IGBT

Gate voltage vs gate charge
 $V_{GE} = f(Q_g)$



$I_C = 30$ A
 $T_j = 25$ °C



Inverter Diode Characteristics

figure 7. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

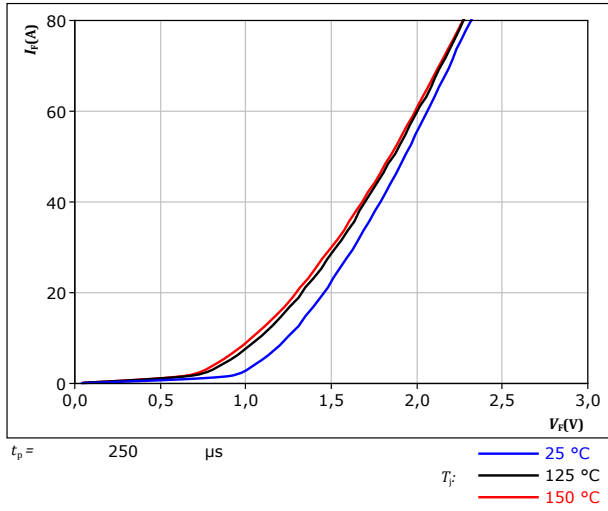
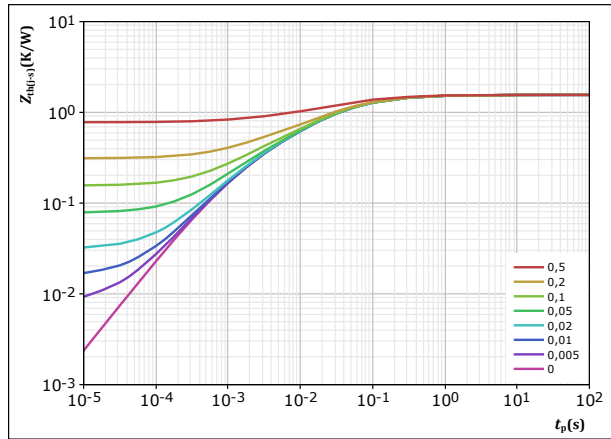


figure 8. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	1,558	K/W
FWD thermal model values		
R (K/W)	τ (s)	
4,84E-02	3,08E+00	
3,87E-01	1,73E-01	
7,62E-01	2,49E-02	
2,92E-01	3,18E-03	
6,90E-02	6,08E-04	

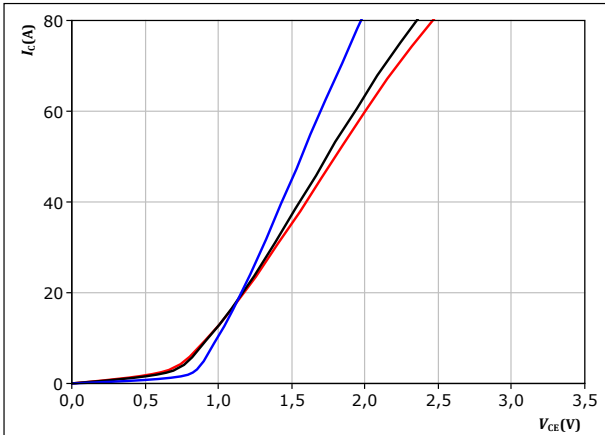


Brake Switch Characteristics

figure 9. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

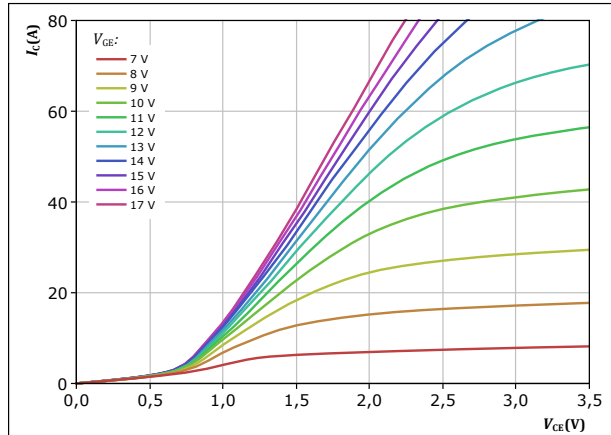


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 10. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

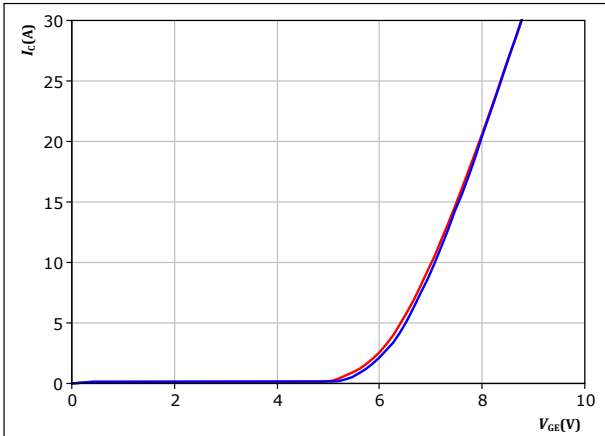


$t_p = 250 \mu s$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 11. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

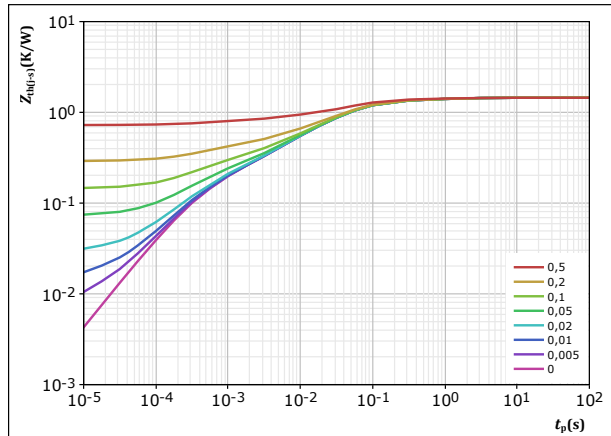


$t_p = 250 \mu s$
 $V_{CE} = 9 V$
 $T_j:$ — 125 °C
— 150 °C

figure 12. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,448 \text{ K/W}$
IGBT thermal model values

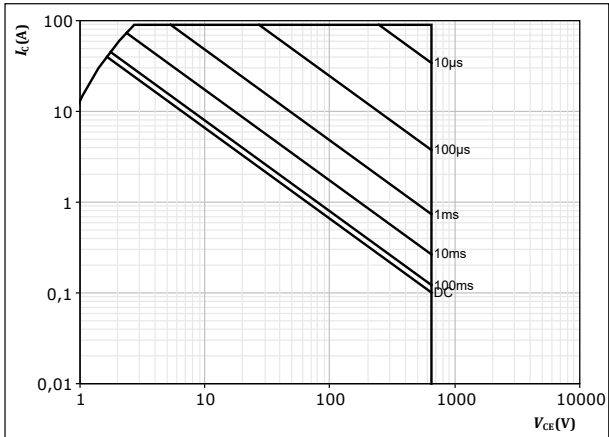
R (K/W)	τ (s)
8,39E-02	1,48E+00
2,97E-01	1,38E-01
7,21E-01	3,10E-02
2,11E-01	3,93E-03
1,36E-01	3,86E-04



Brake Switch Characteristics

figure 13. IGBT

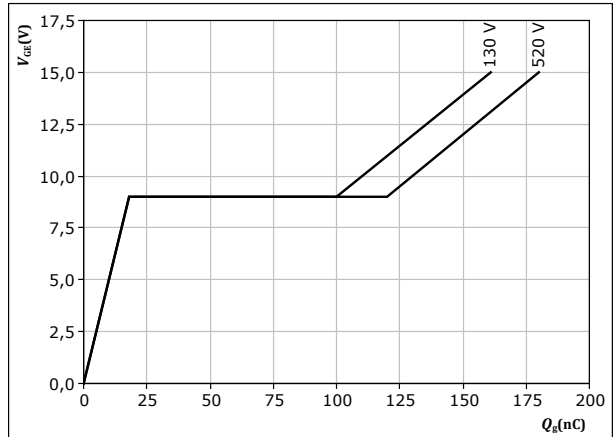
Safe operating area
 $I_C = f(V_{CE})$



$D =$ single pulse
 $T_s = 80$ °C
 $V_{GE} = 15$ V
 $T_j = T_{jmax}$

figure 14. IGBT

Gate voltage vs gate charge
 $V_{GE} = f(Q_g)$



$I_C = 30$ A
 $T_j = 25$ °C



Brake Diode Characteristics

figure 15. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

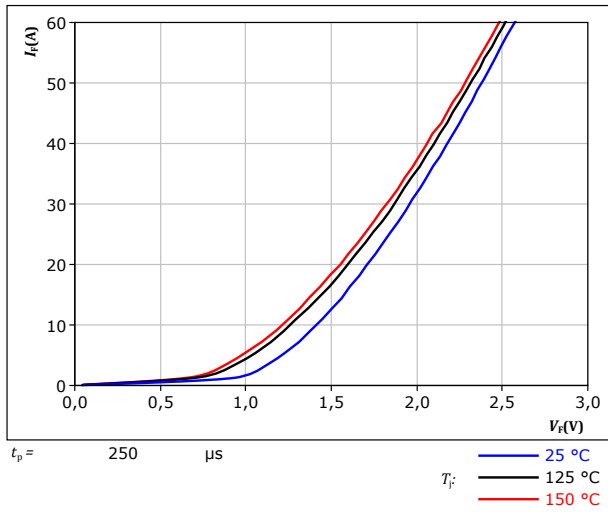
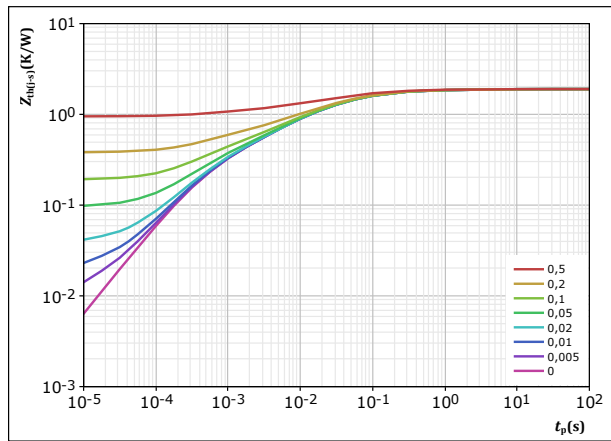


figure 16. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	1,899	K/W
FWD thermal model values		
R (K/W)	τ (s)	
6,60E-02	3,50E+00	
4,15E-01	1,56E-01	
7,82E-01	2,46E-02	
4,19E-01	3,71E-03	
2,17E-01	4,40E-04	



Rectifier Diode Characteristics

figure 17. Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$

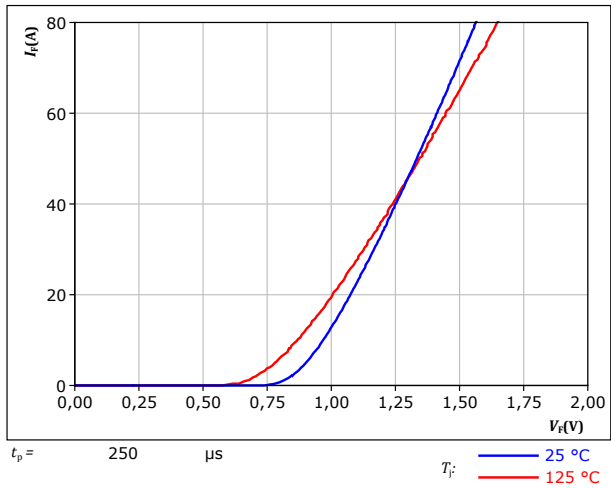
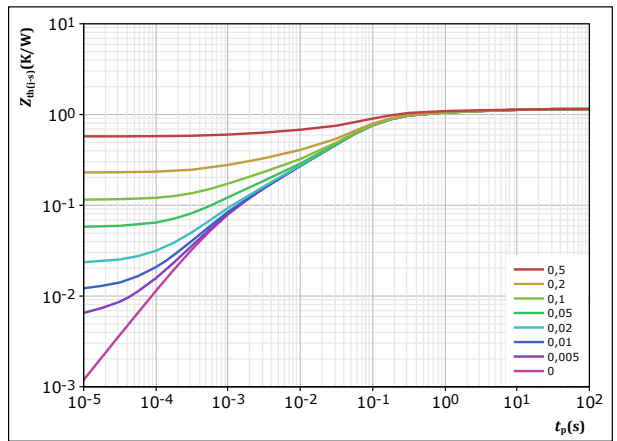


figure 18. Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,149 \text{ K/W}$

Rectifier thermal model values

R (K/W)	τ (s)
8,29E-02	7,59E+00
1,02E-01	6,72E-01
4,20E-01	1,19E-01
3,78E-01	4,22E-02
1,08E-01	4,04E-03
5,78E-02	7,21E-04

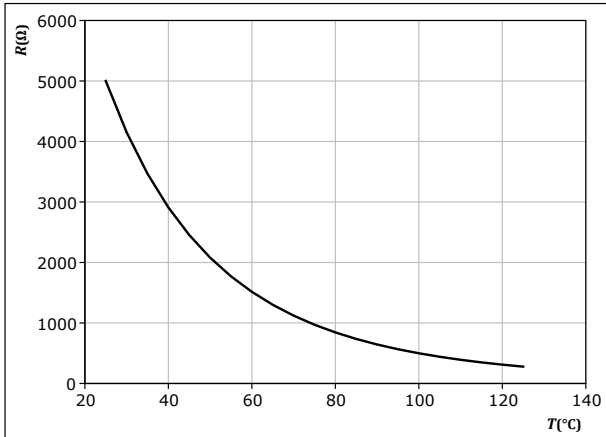


Thermistor Characteristics

figure 19. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

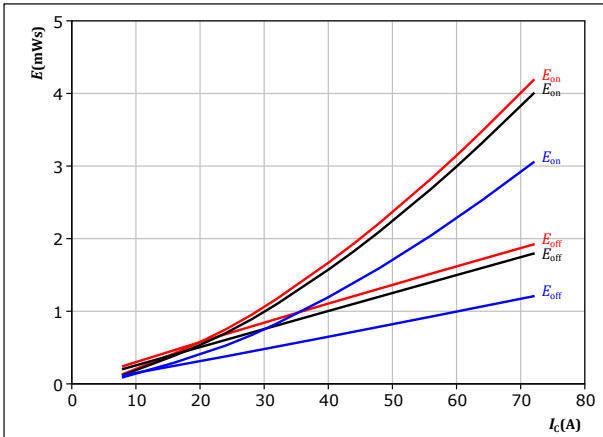




Inverter Switching Characteristics

figure 20. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

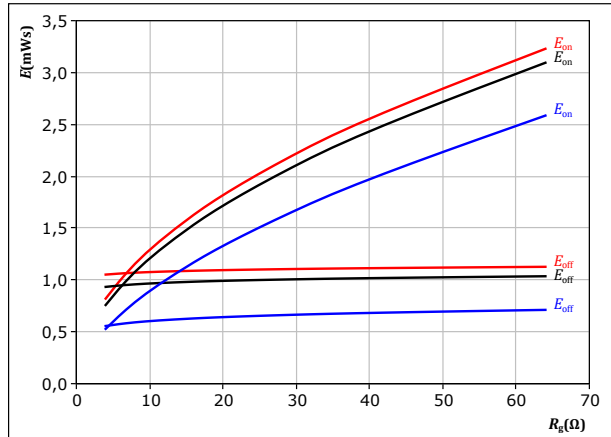


With an inductive load at

$V_{CE} = 350 \text{ V}$	$T_j: 25 \text{ }^\circ\text{C}$
$V_{GE} = \pm 15 \text{ V}$	$125 \text{ }^\circ\text{C}$
$R_{g\text{on}} = 16 \ \Omega$	$150 \text{ }^\circ\text{C}$
$R_{g\text{off}} = 16 \ \Omega$	

figure 21. IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor
 $E = f(R_g)$

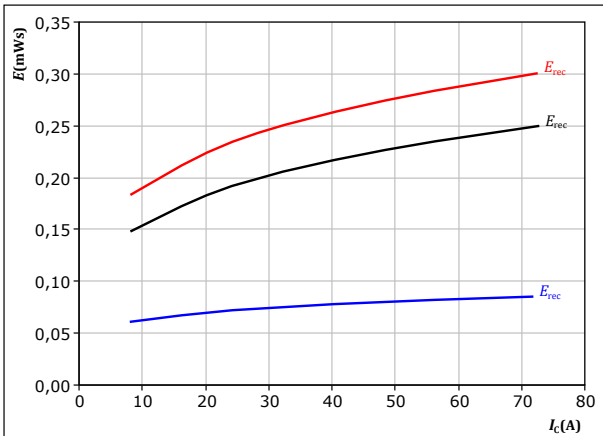


With an inductive load at

$V_{CE} = 350 \text{ V}$	$T_j: 25 \text{ }^\circ\text{C}$
$V_{GE} = \pm 15 \text{ V}$	$125 \text{ }^\circ\text{C}$
$I_c = 40 \text{ A}$	$150 \text{ }^\circ\text{C}$

figure 22. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

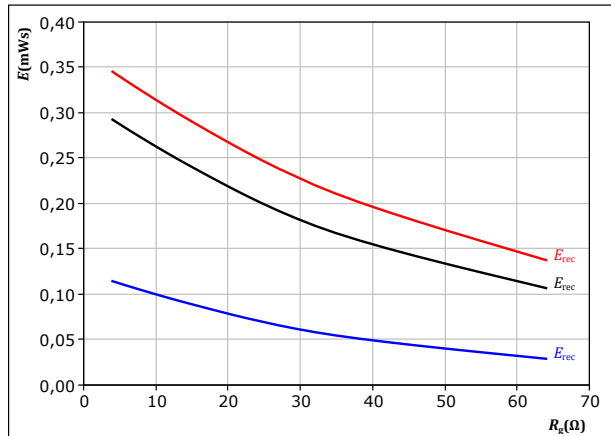


With an inductive load at

$V_{CE} = 350 \text{ V}$	$T_j: 25 \text{ }^\circ\text{C}$
$V_{GE} = \pm 15 \text{ V}$	$125 \text{ }^\circ\text{C}$
$R_{g\text{on}} = 16 \ \Omega$	$150 \text{ }^\circ\text{C}$

figure 23. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

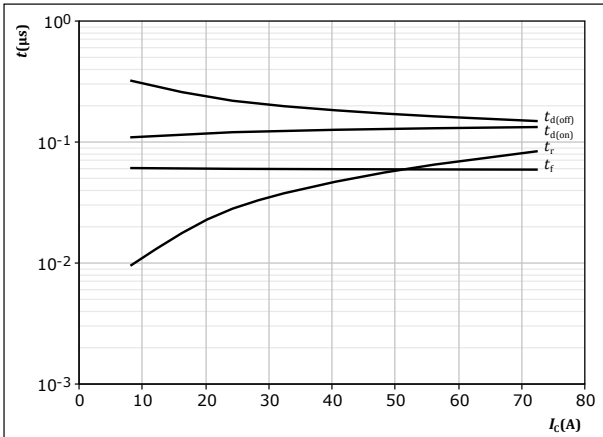
$V_{CE} = 350 \text{ V}$	$T_j: 25 \text{ }^\circ\text{C}$
$V_{GE} = \pm 15 \text{ V}$	$125 \text{ }^\circ\text{C}$
$I_c = 40 \text{ A}$	$150 \text{ }^\circ\text{C}$



Inverter Switching Characteristics

figure 24. IGBT

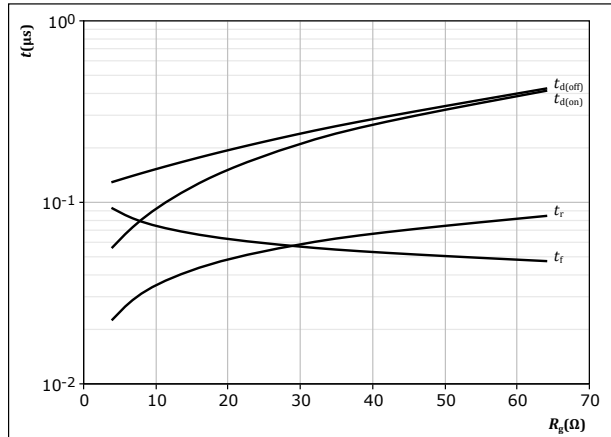
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$
 $R_{goff} = 16 \text{ } \Omega$

figure 25. IGBT

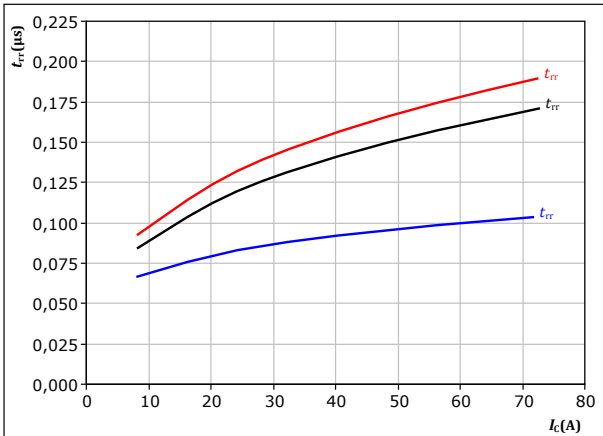
Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 40 \text{ A}$

figure 26. FWD

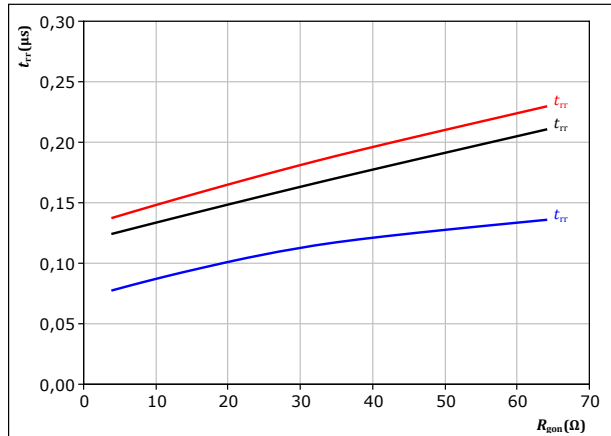
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 27. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 40 \text{ A}$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

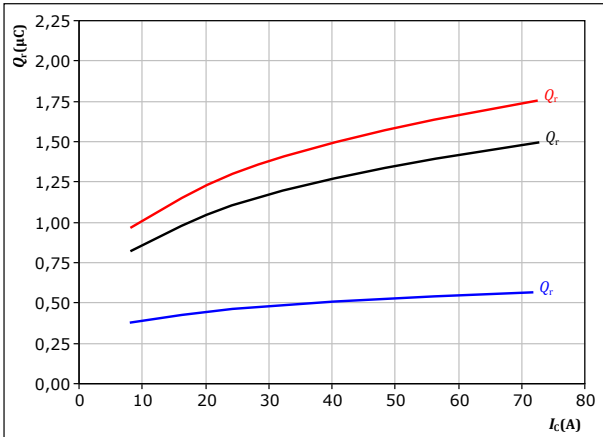


Inverter Switching Characteristics

figure 28. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



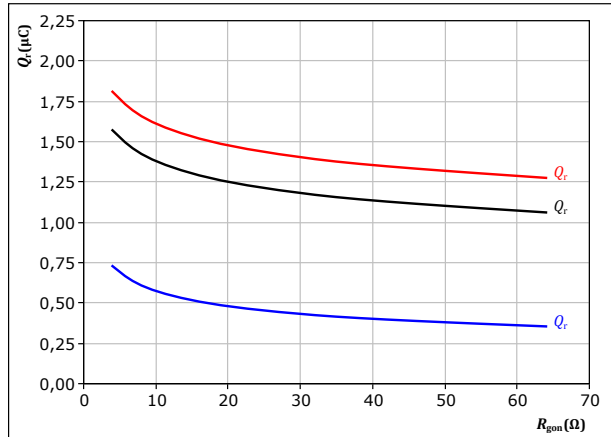
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 $T_j: 25$ °C
 125 °C
 150 °C

figure 29. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



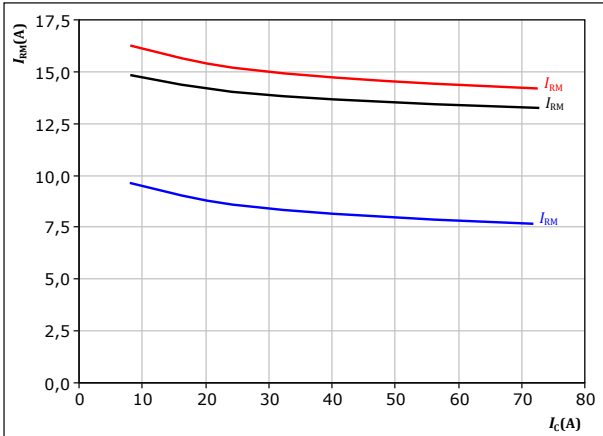
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 40$ A
 $T_j: 25$ °C
 125 °C
 150 °C

figure 30. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



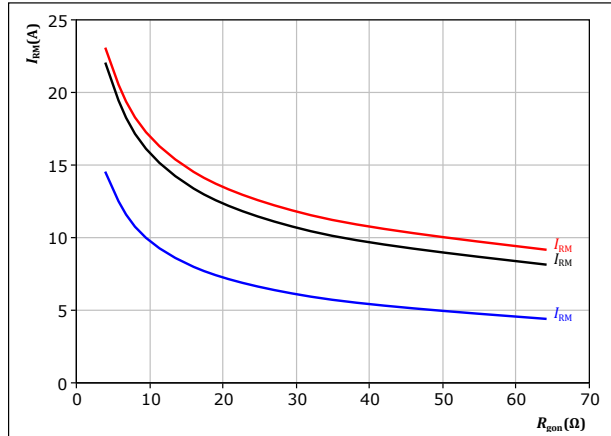
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 $T_j: 25$ °C
 125 °C
 150 °C

figure 31. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

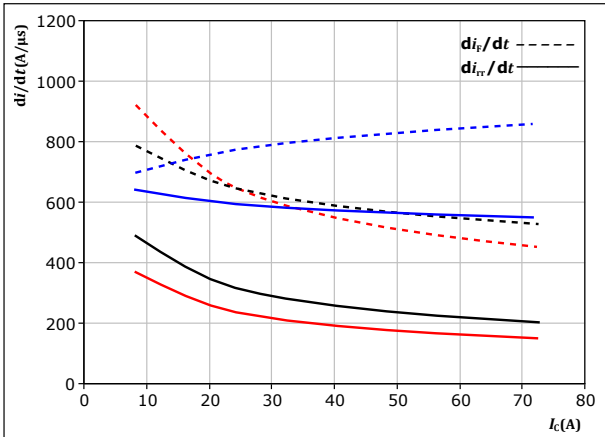
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 40$ A
 $T_j: 25$ °C
 125 °C
 150 °C



Inverter Switching Characteristics

figure 32. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_C)$

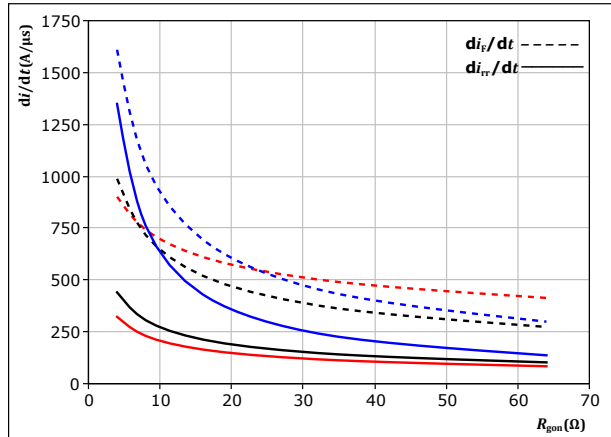


With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \ \Omega$

$T_j =$
— 25 °C
— 125 °C
— 150 °C

figure 33. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$

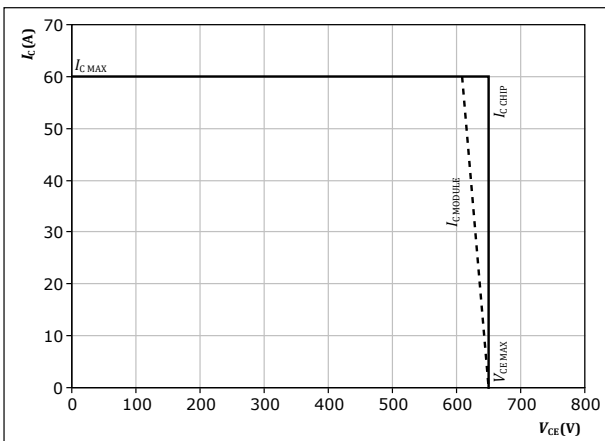


With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 40 \text{ A}$

$T_j =$
— 25 °C
— 125 °C
— 150 °C

figure 34. IGBT

Reverse bias safe operating area
 $I_C = f(V_{CE})$



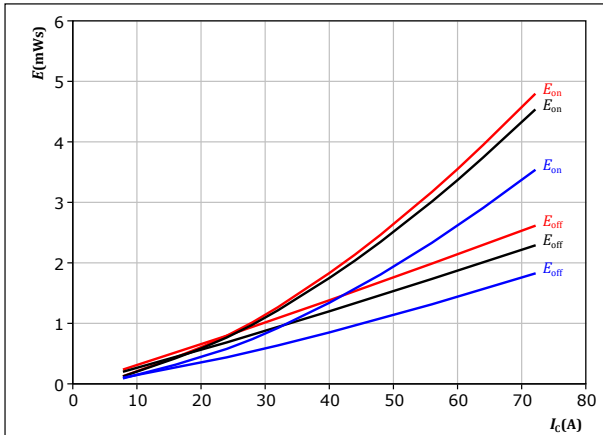
At $T_j = 150 \text{ °C}$
 $R_{gon} = 16 \ \Omega$
 $R_{goff} = 16 \ \Omega$



Brake Switching Characteristics

figure 35. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

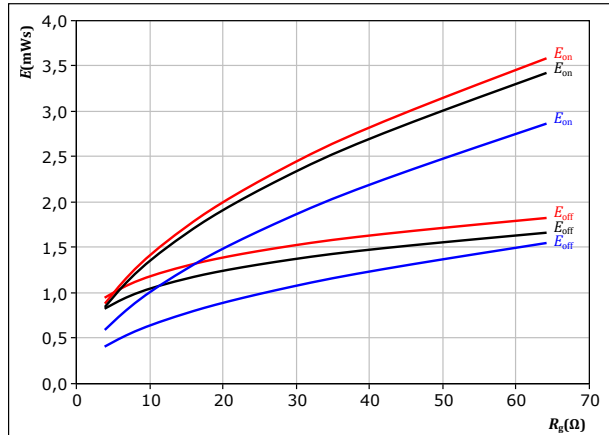


With an inductive load at

$V_{CE} = 400$ V	$T_j:$ 25 °C
$V_{GE} = 0/15$ V	125 °C
$R_{g(on)} = 16$ Ω	150 °C
$R_{g(off)} = 16$ Ω	

figure 36. IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor
 $E = f(R_g)$

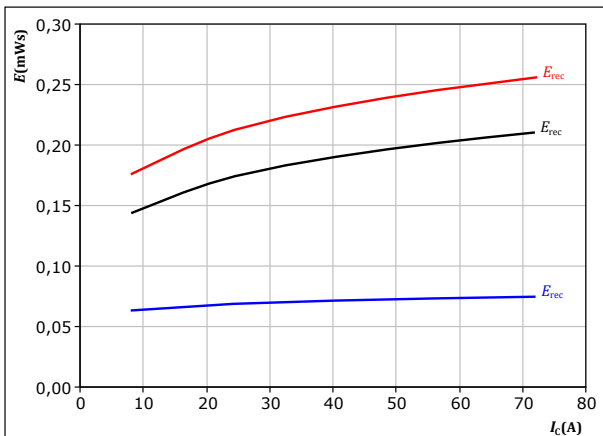


With an inductive load at

$V_{CE} = 400$ V	$T_j:$ 25 °C
$V_{GE} = 0/15$ V	125 °C
$I_c = 40$ A	150 °C

figure 37. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

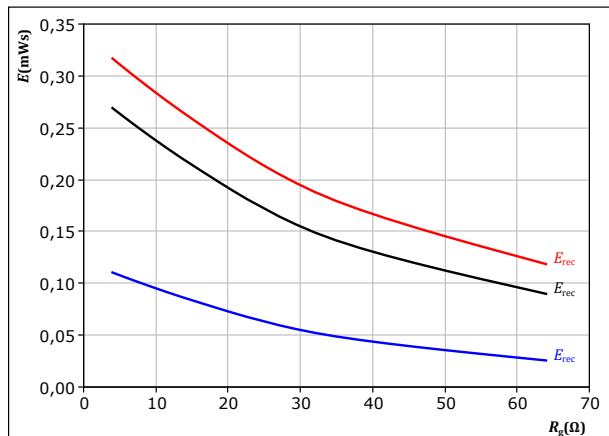


With an inductive load at

$V_{CE} = 400$ V	$T_j:$ 25 °C
$V_{GE} = 0/15$ V	125 °C
$R_{g(on)} = 16$ Ω	150 °C

figure 38. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

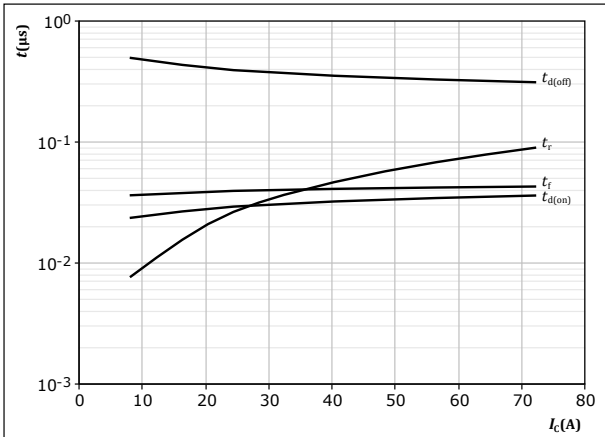
$V_{CE} = 400$ V	$T_j:$ 25 °C
$V_{GE} = 0/15$ V	125 °C
$I_c = 40$ A	150 °C



Brake Switching Characteristics

figure 39. IGBT

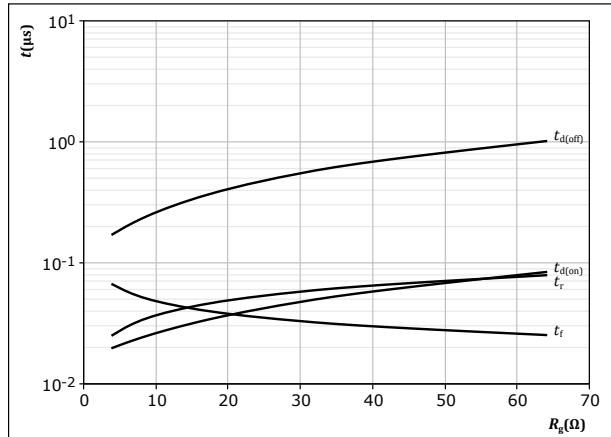
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$
 $R_{goff} = 16 \text{ } \Omega$

figure 40. IGBT

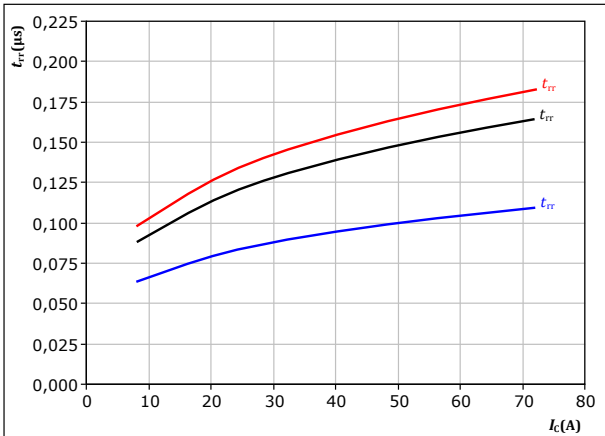
Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 40 \text{ A}$

figure 41. FWD

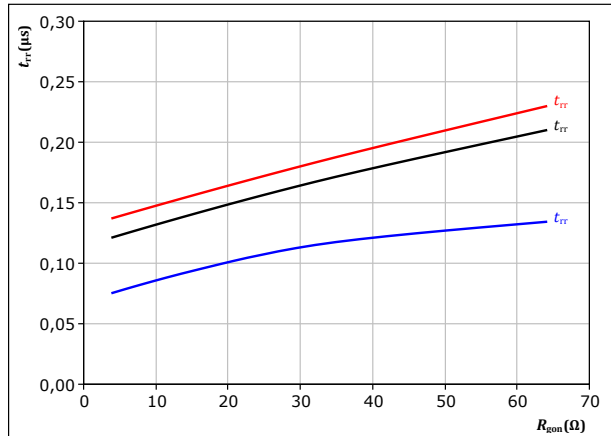
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 42. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 40 \text{ A}$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

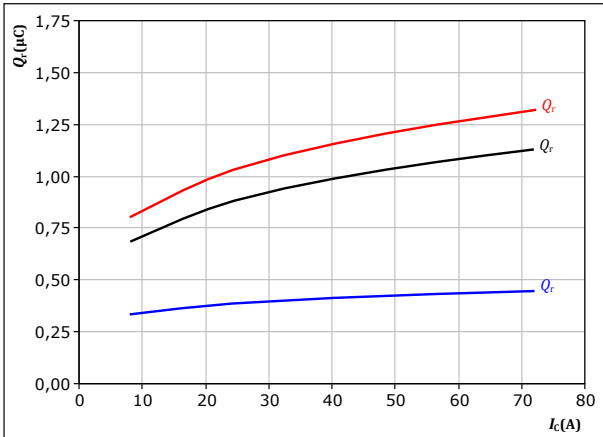


Brake Switching Characteristics

figure 43. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

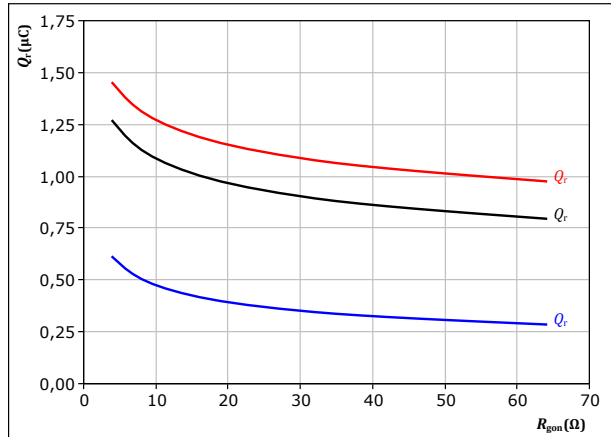
$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 16$ Ω

T_j : — 25 °C
— 125 °C
— 150 °C

figure 44. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

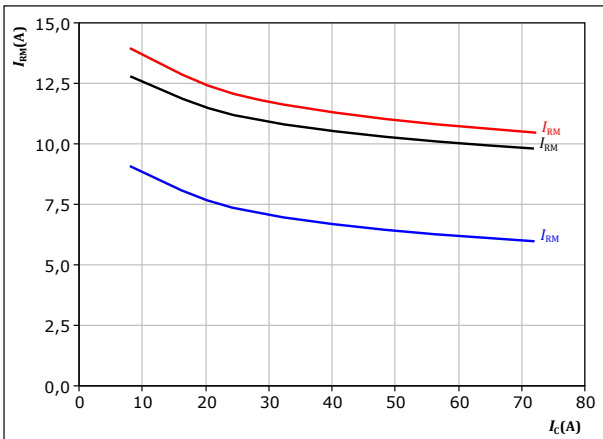
$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 40$ A

T_j : — 25 °C
— 125 °C
— 150 °C

figure 45. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

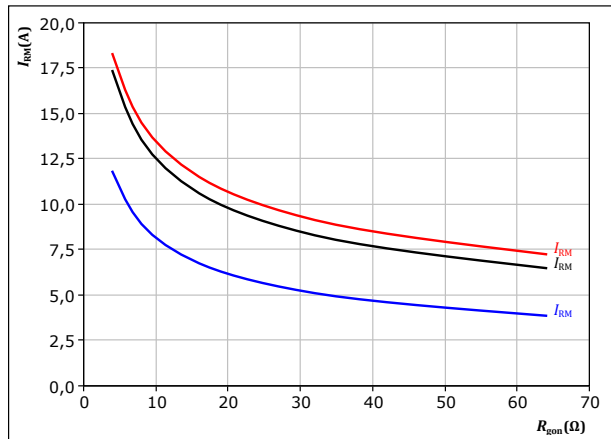
$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 16$ Ω

T_j : — 25 °C
— 125 °C
— 150 °C

figure 46. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 40$ A

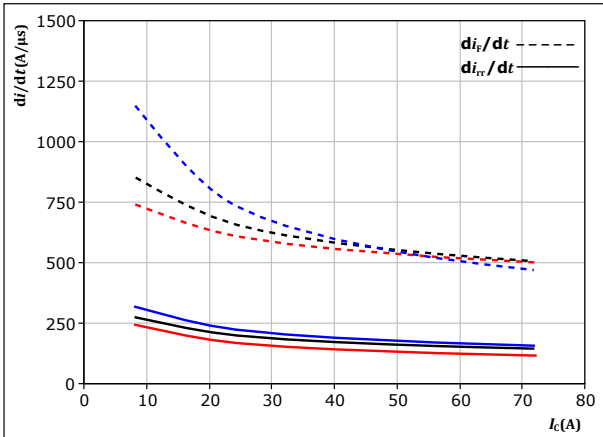
T_j : — 25 °C
— 125 °C
— 150 °C



Brake Switching Characteristics

figure 47. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_C)$

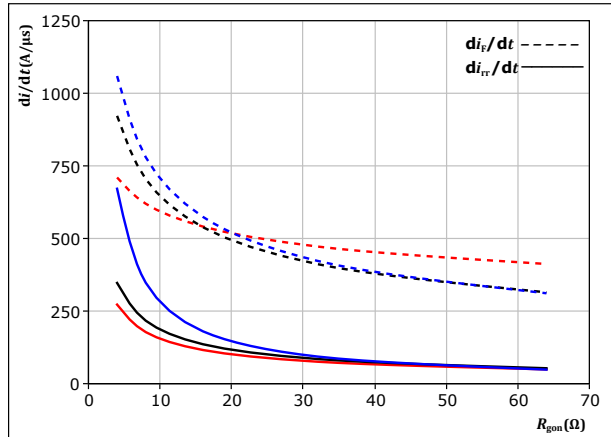


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 16$ Ω

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 48. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



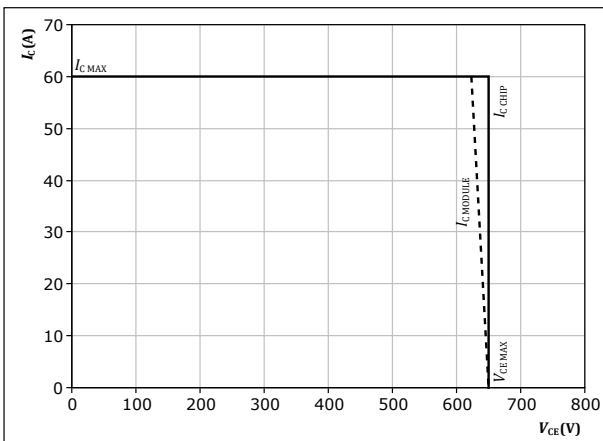
With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_C = 40$ A

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 49. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 16$ Ω
 $R_{goff} = 16$ Ω



Switching Definitions

figure 50. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

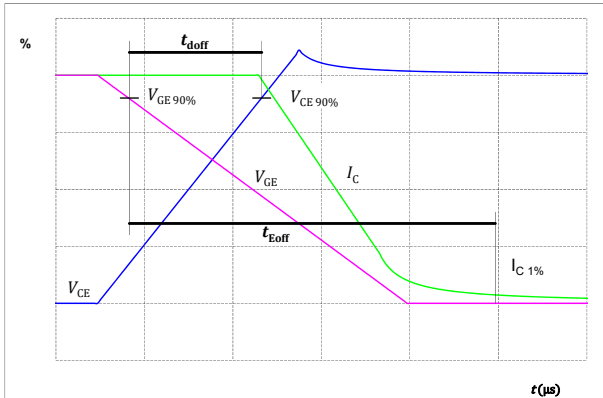


figure 51. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

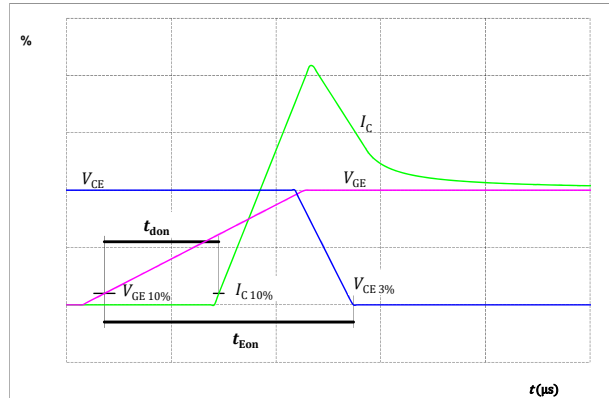


figure 52. IGBT

Turn-off Switching Waveforms & definition of t_f

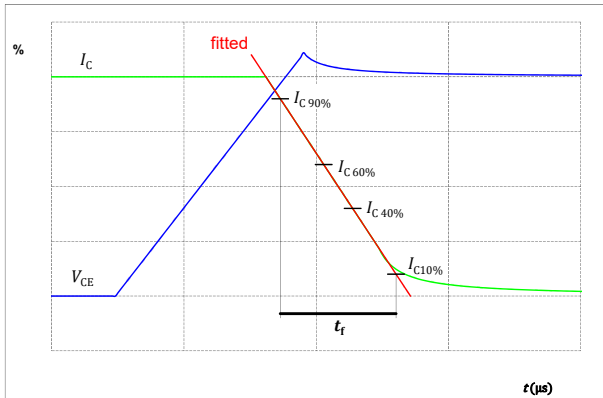
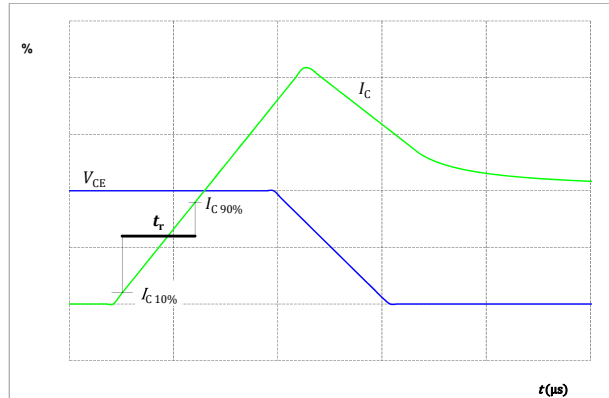


figure 53. IGBT

Turn-on Switching Waveforms & definition of t_r





Switching Definitions

figure 54. FWD

Turn-off Switching Waveforms & definition of t_{rr}

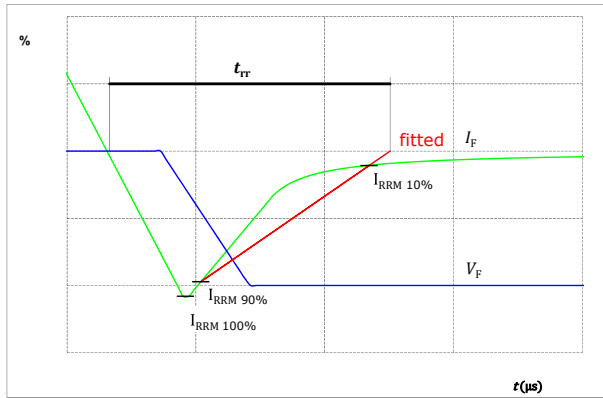
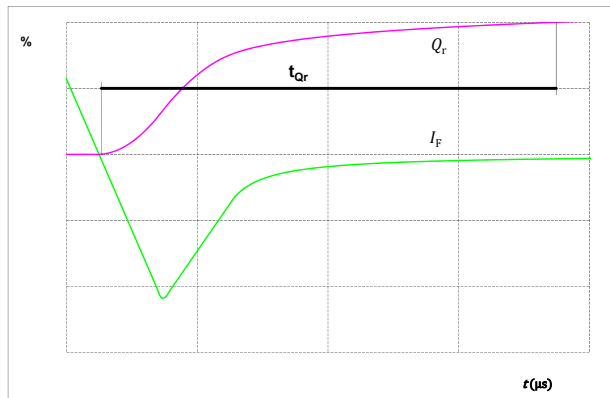


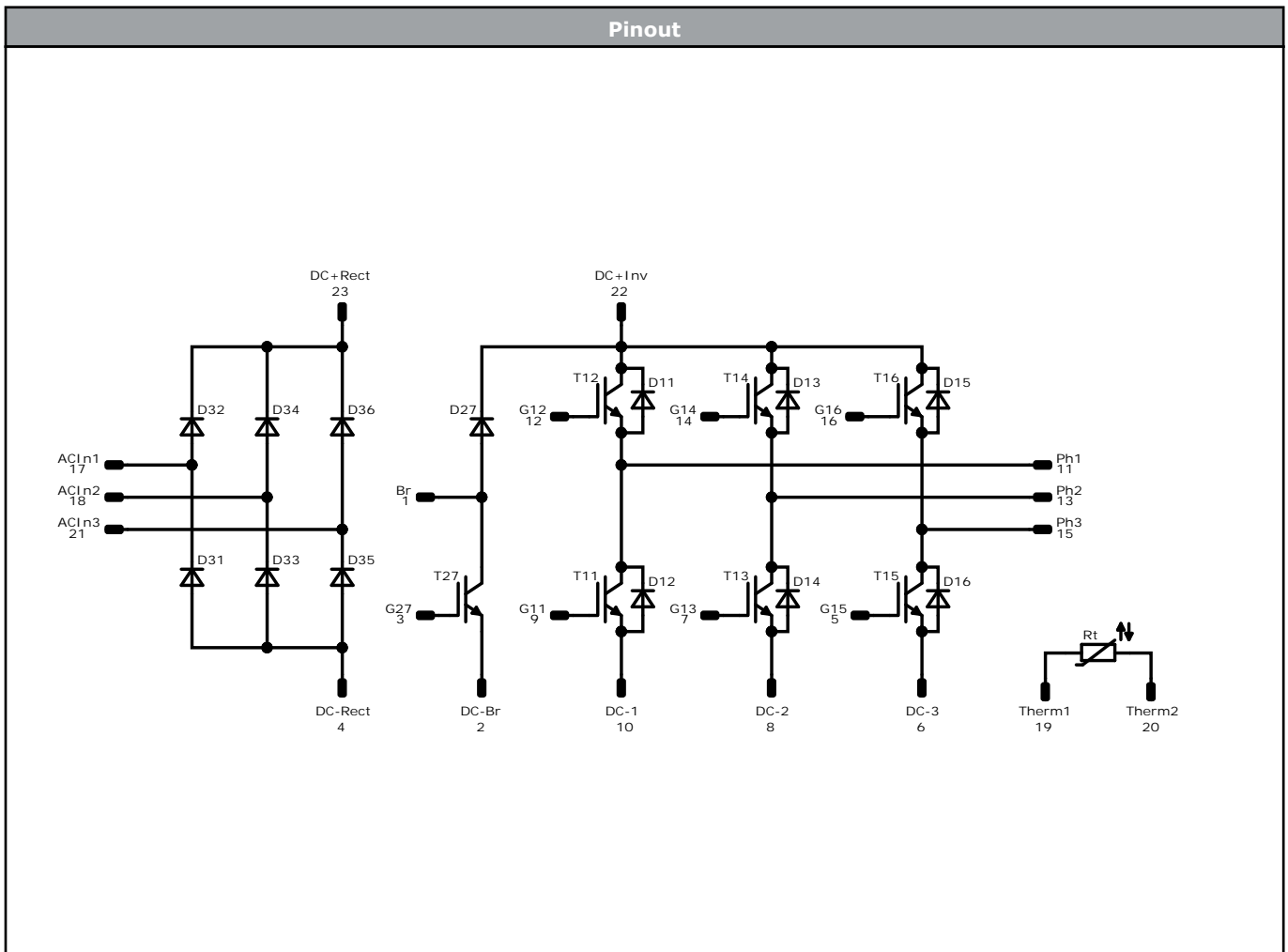
figure 55. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	650 V	30 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	650 V	30 A	Inverter Diode	
T27	IGBT	650 V	30 A	Brake Switch	
D27	FWD	650 V	20 A	Brake Diode	
D31, D32, D33, D34, D35, D36	Rectifier	1600 V	28 A	Rectifier Diode	
Rt	NTC			Thermistor	



Vincotech

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow</i> E1 packages see vincotech.com website.

Package data
Package data for <i>flow</i> E1 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is UL 1557 recognized under E192116 up to a junction temperature under switching condition $T_{j,op}=175^{\circ}\text{C}$ and up to 3500VAC/1min isolation voltage. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-E107PMA030I7-L926A28Z-D1-14	7 Aug. 2024	Initial Release	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.